PCN Number: 2023			30329002.1		PCN Date:		e:	March 30, 2023			
Title: Qualification of DM				OS6 as an additional Fab site option for select LBC9 devices							
Customer Contact:				PCN Manager			Dept:			Quality Services	
Proposed 1 st Ship Date:							Sample requests accepted until:			April 29, 2023*	
*Sa	*Sample requests received after April 29, 2023 will not be supported.							l .			
Change Type:											
	☐ Assembly Site			Assembly Process				Assembly Materials			
Design			Electrical Specification				Mechanical Specification				
Test Site			Packing/Shipping/Labeling		ng		Test Process				
☐ Wafer Bump Site				Wafer Bump Material				Wafer Bump Process			
				Wafer Fab Materials				Wafer Fab Process			
					☐ Part number change						
PCN Details											

Description of Change:

Texas Instruments is pleased to announce the qualification of its DMOS6 fabrication facility as an additional Wafer Fab source for the selected devices listed in the "Product Affected" section.

С	urrent Fab Site	9	Additional Fab Site			
Current Fab Site	Process	Wafer Diameter	New Fab Site	Process	Wafer Diameter	
RFAB	LBC9	300mm	DMOS6	LBC9	300mm	

Qual details are provided in the Qual Data Section.

Reason for Change:

Continuity of supply.

Anticipated impact on Form, Fit, Function, Quality or Reliability (positive / negative):

None

Changes to product identification resulting from this PCN:

Fab Site Information:

Chip Site	Chip Site Origin Code (20L)	Chip Site Country Code (21L)	Chip Site City
RFAB	RFB	USA	Richardson
DMOS6	DM6	USA	Dallas

Sample product shipping label (not actual product label)



A (L)TO:1750



(1P) \$N74L\$07N\$R (Q) 2000 (D) 0336 (31T)LOT: 3959047MLA (4W) TKY(1T) 7523483\$I2 (P) (2P) REV: (V) 0033317 (20L) CSO: SHE (21L) CCO: USA (22L) ASO: MLA (23L) ACO: MYS

Product Affected:

PCM1820IRTER	PCM1822IRTER	PCMD3140IRTER	TLV320ADC5120IRTER
PCM1821IRTER	PCM1822IRTET	TLV320ADC3120IRTER	TLV320ADC6120IRTER

Qualification Report Approve Date 30-JANUARY -2023

Qualification Results

Data Displayed as: Number of lots / Total sample size / Total failed

Туре	#	Test Name	Condition	Duration	Qual Device: TLV320ADC6120IRTER	QBS Process Reference: TMP139AIYAHR	QBS Product and Package Reference: <u>PCM6120QRTERQ1</u>
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	3/231/0	-
HAST	A2	Biased HAST	130C/85%RH	96 Hours	-	-	3/231/0
UHAST	A3	Autoclave	121C/15psig	96 Hours	-	-	3/231/0
UHAST	А3	Unbiased HAST	130C/85%RH	96 Hours	-	3/231/0	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	3/231/0	-
TC	A4	Temperature Cycle	-65C/150C	500 Cycles	-	-	3/231/0
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	3/231/0	-
HTSL	A6	High Temperature Storage Life	150C	1000 Hours	-	-	3/135/0
HTOL	B1	Life Test	125C	1000 Hours	-	3/231/0	-
HTOL	B1	Life Test	125C	1000 Hours	-	-	1/77/0
ELFR	B2	Early Life Failure Rate	125C	48 Hours	-	3/3000/0	-
SD	C3	PB Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	1/15/0
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes)	-	-	-	1/15/0
SD	C3	PB-Free Solderability	Precondition w.155C Dry Bake (4 hrs +/- 15 minutes); PB-Free Solder;	-	-	1/22/0	-
PD	C4	Physical Dimensions	Cpk>1.67	-	-	-	3/30/0
ESD	E2	ESD CDM	-	250 Volts	1/3/0	1/3/0	1/3/0
ESD	E2	ESD HBM	-	1000 Volts	1/3/0	1/3/0	1/3/0
LU	E4	Latch-Up	Per JESD78	-	1/3/0	1/3/0	1/6/0
CHAR	E5	Electrical Characterization	Per Datasheet Parameters	-	1/30/0	1/30/0	3/90/0

- QBS: Qual By Similarity
- Qual Device TLV320ADC6120IRTER is qualified at MSL2 260C
- Note this qualification report also covers the following devices: TLV320ADC5120IRTER, TLV320ADC3120IRTER, PCMD3140IRTER, PCM1822IRTER, PCM1821IRTER, PCM1820IRTER
- Preconditioning was performed for Autoclave, Unbiased HAST, THB/Biased HAST, Temperature Cycle, Thermal Shock, and HTSL, as applicable
- The following are equivalent HTOL options based on an activation energy of 0.7eV : 125C/1k Hours, 140C/480 Hours, 150C/300 Hours, and 155C/240 Hours
- The following are equivalent HTSL options based on an activation energy of 0.7eV : 150C/1k Hours, and 170C/420 Hours
- The following are equivalent Temp Cycle options per JESD47 : -55C/125C/700 Cycles and -65C/150C/500 Cycles

Quality and Environmental data is available at Tl's external Web site: http://www.ti.com/

Green/Pb-free Status:

Qualified Pb-Free(SMT) and Green

For questions regarding this notice, e-mails can be sent to the contact shown below, or you can contact your local Field Sales Representative.

Location	E-Mail
WW Change Management Team	PCN ww admin team@list.ti.com

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